SCOPE:

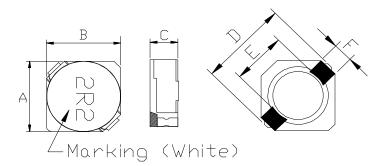
This specification applies to the Pb Free high current type SMD inductors for MSCDRI-3D14LD-SERIES

PRODUCT INDENTIFICATION

MSCDRI-3D14LD-100 M

- 1
- 2
- 3 4
- 1 Product Code
- **2 Dimensions Code**
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 3.80±0.2 mm

B: 3.80±0.2 mm

C: 1.50 Max. mm

D: 5.20 Max. mm

E: 2.80 Typ. mm

F: 1.10 Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature +60°C Max.
- (3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)
- (3)-3 Storage temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$



TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current		Markins	
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	IDC1(A)	IDC2(A)	Marking	
MSCDRI-3D14LD-1R2	1.2	N	100kHz/0.25V	38m	1.50	2.70	1R2	
MSCDRI-3D14LD-1R5	1.5	N	100kHz/0.25V	48m	1.35	2.40	1R5	
MSCDRI-3D14LD-2R0□	2.0	N	100kHz/0.25V	55m	1.15	2.20	2R0	
MSCDRI-3D14LD-2R2	2.2	M,N	100kHz/0.25V	55m	1.15	2.20	2R2	
MSCDRI-3D14LD-2R5	2.5	N	100kHz/0.25V	68m	1.05	1.90	2R5	
MSCDRI-3D14LD-3R0	3.0	N	100kHz/0.25V	77m	0.95	1.60	3R0	
MSCDRI-3D14LD-3R9	3.9	N	100kHz/0.25V	96m	0.80	1.50	3R9	
MSCDRI-3D14LD-4R5	4.5	N	100kHz/0.25V	0.105	0.75	1.45	4R5	
MSCDRI-3D14LD-5R6□	5.6	N	100kHz/0.25V	0.159	0.70	1.10	5R6	
MSCDRI-3D14LD-6R8□	6.8	N	100kHz/0.25V	0.173	0.60	1.05	6R8	
MSCDRI-3D14LD-100	10	M,N	100kHz/0.25V	0.220	0.50	1.00	100	
MSCDRI-3D14LD-120	12	M,N	100kHz/0.25V	0.270	0.45	0.80	120	
MSCDRI-3D14LD-150	15	M,N	100kHz/0.25V	0.302	0.40	0.75	150	
MSCDRI-3D14LD-220	22	M,N	100kHz/0.25V	0.447	0.35	0.60	220	
MSCDRI-3D14LD-330	33	M,N	100kHz/0.25V	0.848	0.30	0.40	330	
MSCDRI-3D14LD-470	47	M,N	100kHz/0.25V	1.080	0.25	0.35	470	

※ IDC1: Based on inductance change (△L/Lo: drop 35% max)

IDC2: Based on temperature rise ($\triangle T$: 40°C TYP.)

Rated DC Current: The less value which is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damege.	Л			
		R5 45±2 45±2 10 20 10 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
Solderability	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130~150℃ and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			

MECHANICAL

	SPECIFICATION					
There shall be no damage or problems.	Temperature profile of reflow soldering soldering (Peak temperature 200±3° 10 sec 150 Pre-heating 150 2 min (230° °) Slow cooling (Stored at room temperature) The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions					
	no damage or					

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃ ,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.

ENVIROMENT CHARACTERISTICS

TEST ITEM	CHARACTE	CHARACTERISTICS SDECIFICATION						
1201112111	↑ 1 /1 ~ < ±E0/	SPECIFICATION						
High temperature	∆L/Lo≦±5%		The sample shall be left for 96±4 hours in an atmospere with					
storage		_	a temperature of 85±2℃ and a normal humidity.					
	There shall be	-	Upon completion of the measurement shall be made after the					
	no mechanical	-	sample has been left in a normal temperature and normal					
	damage.	humidity	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The sam	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a tempe	a temperature of -25±3℃.					
	There shall be	Upon co	Upon completion of the test, the measurement shall be made					
	no mechanical	after the	samp	ole has been left in a no	rmal temperature and	1		
	damage.	normal l	normal humidity for 1 hour.					
Change of	∆L/Lo≦±5%	The sam	The sample shall be subject to 5 continuos cycles, such as shown					
temperature		in the ta	ble 2 k	below and then it shall b	pe subjected to stand	ard		
	There shall be	atmospl	atmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be	made					
	ge of problems							
			table 2					
				Temperature	Duration]		
			1	–25±3 ℃	30 min.]		
			!	(Themostat No.1)				
			2	Standard	No 1 ×No 2]		
			!	atmospheric	No.1→No.2			
			3	85±2℃	30 min.]		
			-	(Themostat No.2)				
			4	Standard	N- O . No 4	1		
				atmospheric	No.2→No.1			
Maria et es	A 1 /1 - < ±E0/	The con		!! be left for OC±4 born	! c termporeture of	<u></u>		
Moisuture storage	∆L/Lo≦±5%		-	nall be left for 96±4 hour	_			
		_		humidity(RH) of $90\sim95^{\circ}$		•.		
	There shall be	·	•	ion of the test, the mea				
	no mechanical		•	ole has been left in a no	rmal temperature and	Į		
	damage.	normai	numiai	ity more than 1 hour.				
Test conditions:								
The s	ample shall be reflov	N soldered	onto	the printed circuit boar	d in every test.			

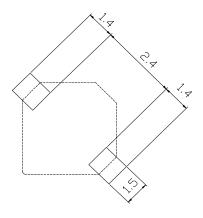


(5) LAND DIMENSION (Ref.)

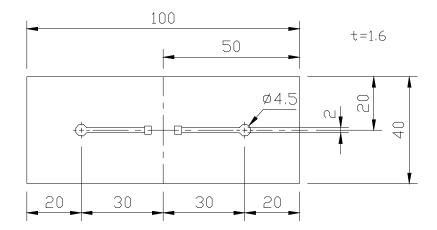
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit: mm



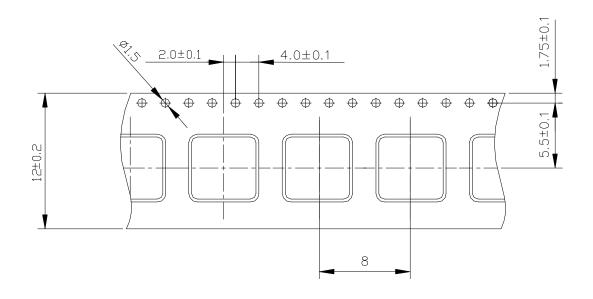
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD





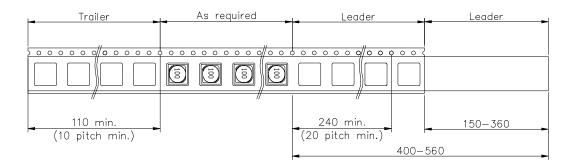
(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

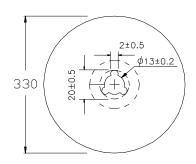


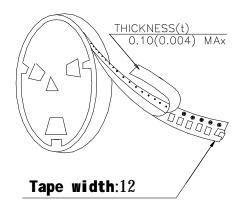
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

3500pcs/Reel

The products are packaged so that no damage will be sustained.